

FEATURES

- | 350W Peak Pulse Power per Line (tp=8/20μs)
- | Protects tow I/O lines
- | Low clamping voltage
- | Working voltages : 24V
- | Low Leakage current
- | Response time is < 1 ns
- | Meet AEC-Q101 Requirements

APPLICATIONS

- | High-Speed Data Transmission Interfaces
- | Cellular Phones
- | Portable Electronics
- | Wireless Bus Protection



SOT-23



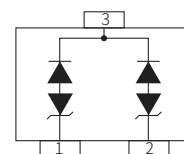
Marking

IEC COMPATIBILITY

- | IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- | IEC61000-4-4 (EFT) 40A (5/50ns)

APPROVALS

- RoHS** | Compliance with 2011/65/EU
- HF** | Compliance with IEC61249-2-21:2003



Schematic Symbol

THERMAL CONSIDERATIONS

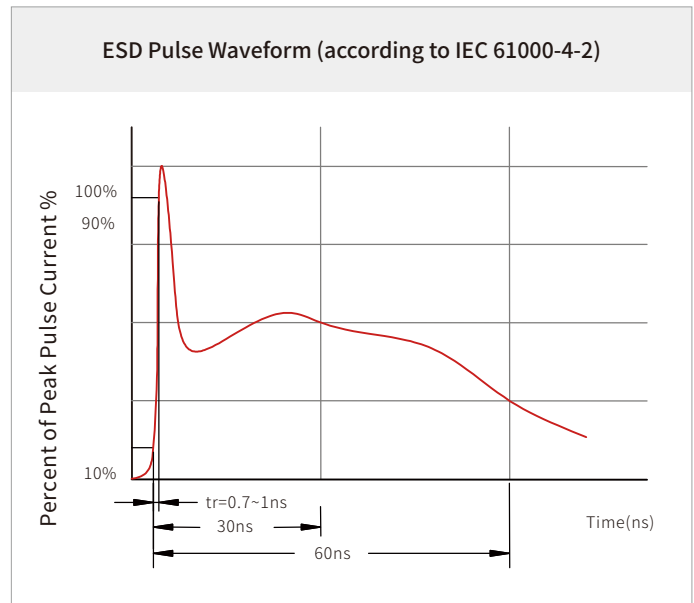
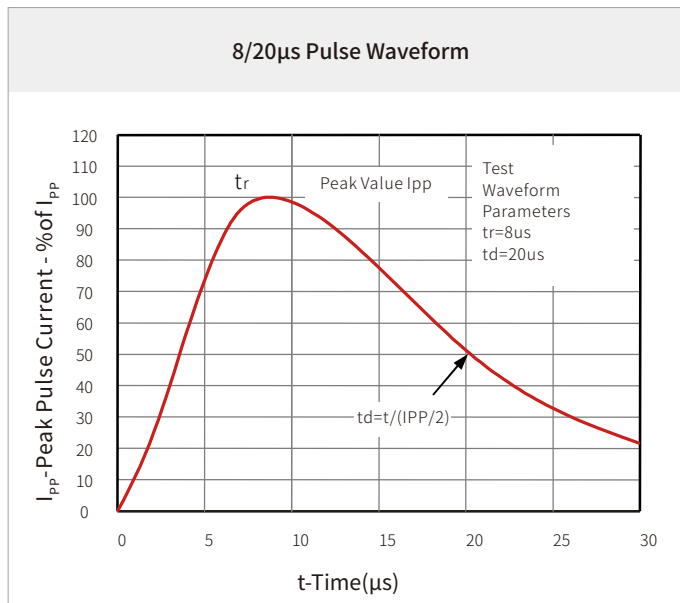
Symbol	Parameter	Value	Unit
P_{pp}	Peak Pulse Power (tp=8/20μs waveform)	350	Watts
T_J	Operating Temperature Range	-55 to +150	°C
T_{STG}	Storage Temperature Range	-55 to +150	°C

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{RWM}	Reverse Stand-off Voltage				24	V
V_{BR}	Reverse Breakdown Voltage	$I_T=1mA$	26.7			V
I_R	Reverse Leakage Current	$V_{RWM}=24V$			1	μA
V_C	Clamping Voltage	$I_{pp}=1A, tp=8/20\mu s$			43	V
V_C	Clamping Voltage	$I_{pp}=5A, tp=8/20\mu s$			55	V
V_C	Clamping Voltage	$I_{pp}=6A, tp=8/20\mu s$			56	V
I_{PP}	Peak Pulse Current	$tp=8/20\mu s$			6	A
C_J	Off State Junction Capacitance	$V_R=0V, f=1MHz$		0.8		pF

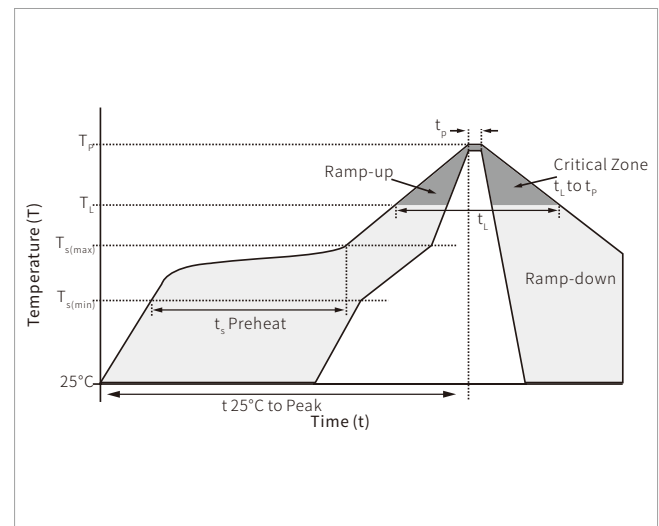
Note: above parameters are Pin 1 or Pin 2 to Pin3.

CHARACTERISTIC CURVES

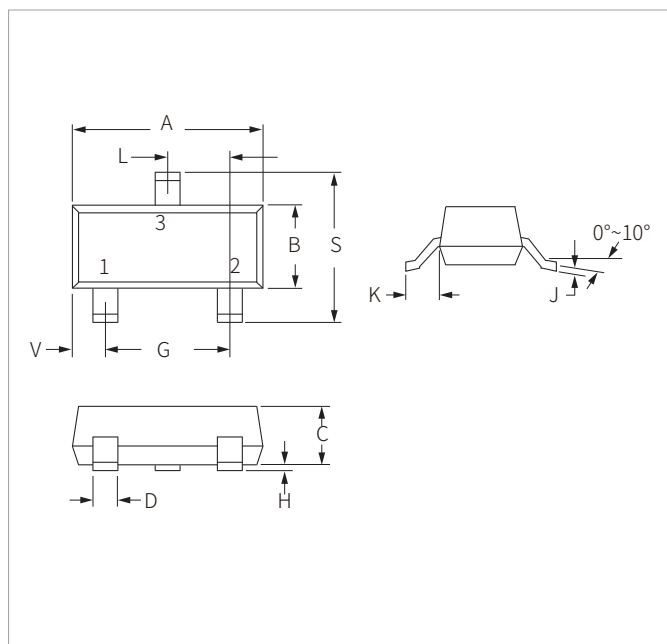


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

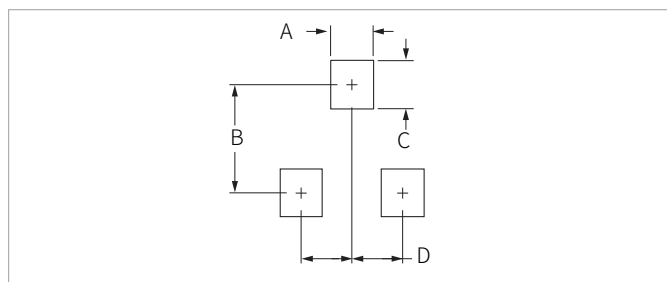


SOT-23 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.80	3.05	0.110	0.120
B	1.20	1.40	0.047	0.055
C	0.90	1.15	0.035	0.045
D	0.37	0.50	0.015	0.020
G	1.75	2.05	0.069	0.081
H	0.01	0.100	0.001	0.004
J	0.085	0.180	0.003	0.007
K	0.35	0.69	0.014	0.029
L	0.89	1.02	0.035	0.040
S	2.10	2.65	0.083	0.104
V	0.45	0.60	0.018	0.024

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.71	0.97	0.028	0.038
B	1.88	2.13	0.074	0.084
C	0.71	0.97	0.028	0.038
D	0.81	1.07	0.032	0.042

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
TPSE23T35B24MB	SOT-23	3000PCS	7"

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